

Bulletin

We hereby certify that the resins below produced by CHIMEI Corporation

POLYLAC® ABS PA-763, PA-763A, PA-764, PA-764B, PA-765, PA-765A, PA-765AJ01, PA-765B, PA-765BJ01

conforms to the requirement that no chemicals as following are added.

- | | |
|---|--|
| 1. PBDEs (Polybrominated Diphenyl Ethers) | 27. Triclosan |
| 2. PBBs (Polybrominated Biphenyls) | 28. Nickel |
| 3. Ozone Depleting Chemicals (CFCs & HCFCs) | 29. PAHs (Polycyclic Aromatic Hydrocarbons) |
| 4. Chlorinated Paraffin (C10-C13) | 30. REACH- Candidate List of SVHC |
| 5. Polyvinyl Chloride (PVC) | 31. Radioactive Substances |
| 6. Mercury (Hg) and its compounds | 32. Natural Latex |
| 7. Lead (Pb) and its compounds | 33. Dioxins and furans |
| 8. Cadmium (Cd) and its compounds | 34. Primary aromatic amines (PAA) |
| 9. Chromium (Cr) and its compounds | 35. Perchlorate |
| 10. Arsenic (As) and its compounds | 36. Hexachlorobenzene |
| 11. Selenium (Se) and its compounds | 37. Mirex |
| 12. Barium (Ba) and its compounds | 38. Specified amine compounds |
| 13. Beryllium (Be) and its compounds | 39. Benzene |
| 14. Bismuth (Bi) and its compounds | 40. Benzenamine, <i>N</i> -phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST) |
| 15. Organic tin compounds (TBT, TPT, DOT, DBT) | 41. Polyamide |
| 16. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs) | 42. PVDC (polyvinylidene chloride) |
| 17. Poly naphthalenes | 43. ESBO (Expoxidized soybean oil) |
| 18. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8) | 44. Formamide |
| 19. Asbestos | 45. Hexabromocyclododecane (HBCDD) |
| 20. Phthalates | 46. Red phosphorus |
| 21. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE) | 47. Aniline · formaldehyde polycondensate |
| 22. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole | 48. Tris (2,3-dibromopropyl) phosphate |
| 23. PFOA, PFOS | 49. Tris (aziridiny) phosphin oxide |
| 24. Bisphenol A | 50. Tri- <i>o</i> -cresyl phosphate |
| 25. Formaldehyde | 51. Tris (2-chloroethyl) phosphate (TCEP) |
| 26. Dimethylfumarate (DMF) | 52. Tris (2-chloro-1-methylethyl) phosphate (TCPP) |
| | 53. Tris (1,3-Dichloro-2-propyl) phosphate (TDCPP) |
| | 54. 4,4'-Sulfonyldiphenol (BPS) |

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (2011/65/EU), 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,

CHIMEI 奇美實業股份有限公司 CHI MEI CORPORATION

ORIGINAL

59-1, San Chia, Jen Te, Tainan City 71702, Taiwan

TEL : (06)2663000 FAX : (06)2665555-7



Perry D. B. Shiueh
Vice President of R&D Division

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHI MEI CORPORATION at the date of issue. CHI MEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHI MEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHI MEI CORPORATION. In no event will CHI MEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.